

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	SKM100GB17E4
Manufacturer:	SEMIKRON
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/semikron/skm100gb17e4.html>

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



SEMITRANS® 2

IGBT4 Modules

SKM100GB17E4

Features

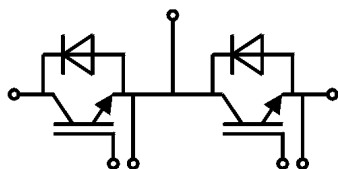
- IGBT4 = 4. generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4. Generation CAL-Diode
- Insulated copper baseplate using DBC Technology (Direct Copper Bonding)
- With integrated Gate resistor
- For switching frequencies up to 8kHz
- UL recognized, file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic welders
- Wind power
- Public transport

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max.
- Recommended $T_{op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for $T_j = 150^\circ\text{C}$



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Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
IGBT				
V _{CES}	T _j = 25 °C		1700	V
I _C	T _j = 175 °C	T _c = 25 °C	164	A
		T _c = 80 °C	127	A
I _{Cnom}			100	A
I _{CRM}	I _{CRM} = 3xI _{Cnom}		300	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 1000 V V _{GE} ≤ 15 V V _{CES} ≤ 1700 V	T _j = 150 °C	10	μs
T _j			-40 ... 175	°C
Inverse diode				
I _F	T _j = 175 °C	T _c = 25 °C	113	A
		T _c = 80 °C	83	A
I _{Fnom}			100	A
I _{FRM}	I _{FRM} = 2xI _{Fnom}		200	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 25 °C		650	A
T _j			-40 ... 175	°C
Module				
I _{t(RMS)}			200	A
T _{stg}			-40 ... 125	°C
V _{isol}	AC sinus 50 Hz, t = 1 min		4000	V

Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
IGBT					
$V_{CE(sat)}$	$I_C = 100\text{ A}$ $V_{GE} = 15\text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$	1.90	2.20	V
		$T_j = 150^\circ\text{C}$	2.30	2.60	V
V_{CE0}	chiplevel	$T_j = 25^\circ\text{C}$	0.8	0.9	V
		$T_j = 150^\circ\text{C}$	0.7	0.8	V
r_{CE}	$V_{GE} = 15\text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$	11	13	$\text{m}\Omega$
		$T_j = 150^\circ\text{C}$	16	18	$\text{m}\Omega$
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 4\text{ mA}$	5.2	5.8	6.4	V
I_{CES}	$V_{GE} = 0\text{ V}$ $V_{CE} = 1700\text{ V}$	$T_j = 25^\circ\text{C}$		1	mA
		$T_j = 150^\circ\text{C}$			mA
C_{ies}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	9		nF
C_{oes}		$f = 1\text{ MHz}$	0.34		nF
C_{res}		$f = 1\text{ MHz}$	0.29		nF
Q_G	$V_{GE} = -8\text{ V} \dots +15\text{ V}$		800		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		7.5		Ω
$t_{d(on)}$	$V_{CC} = 1200\text{ V}$ $I_C = 100\text{ A}$	$T_j = 150^\circ\text{C}$	234		ns
t_r	$V_{GE} = +15/-15\text{ V}$	$T_j = 150^\circ\text{C}$	39		ns
E_{on}	$R_{G on} = 2\text{ }\Omega$	$T_j = 150^\circ\text{C}$	43		mJ
$t_{d(off)}$	$R_{G off} = 2\text{ }\Omega$	$T_j = 150^\circ\text{C}$	657		ns
t_f	$di/dt_{on} = 2540\text{ A}/\mu\text{s}$ $di/dt_{off} = 610\text{ A}/\mu\text{s}$ $du/dt = 5430\text{ V}/\mu\text{s}$	$T_j = 150^\circ\text{C}$	136		ns
E_{off}		$T_j = 150^\circ\text{C}$	39		mJ
$R_{th(j-c)}$	per IGBT			0.234	K/W



SEMITRANS® 2

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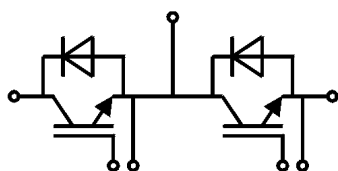
Typical Applications*

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Remarks

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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
V _F = V _{EC}	I _F = 100 A	T _j = 25 °C		2.00	2.40	V
	V _{GE} = 0 V chiplevel	T _j = 150 °C		2.15	2.57	V
V _{F0}	chiplevel	T _j = 25 °C		1.32	1.56	V
		T _j = 150 °C		1.08	1.22	V
r _F	chiplevel	T _j = 25 °C		6.8	8.4	mΩ
		T _j = 150 °C		11	14	mΩ
I _{RRM}	I _F = 100 A	T _j = 150 °C		86		A
Q _{rr}	di/dt _{off} = 2360 A/μs	T _j = 150 °C		34		μC
E _{rr}	V _{GE} = -15 V	T _j = 150 °C		26		mJ
	V _{CC} = 1200 V					
R _{th(j-c)}	per diode				0.504	K/W
Module						
L _{CE}				30		nH
R _{CC'+EE'}	terminal-chip	T _C = 25 °C		0.65		mΩ
		T _C = 125 °C		1.09		mΩ
R _{th(c-s)}	per module			0.04	0.05	K/W
M _s	to heat sink M6		3		5	Nm
M _t		to terminals M5	2.5		5	Nm
						Nm
w					160	g



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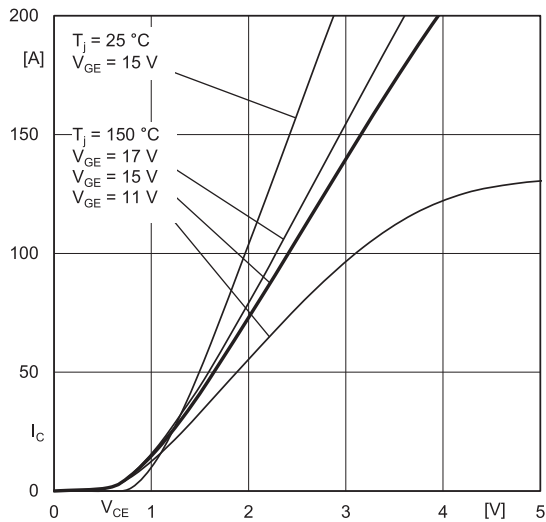


Fig. 1: Typ. output characteristic, inclusive $R_{CC'} + EE'$

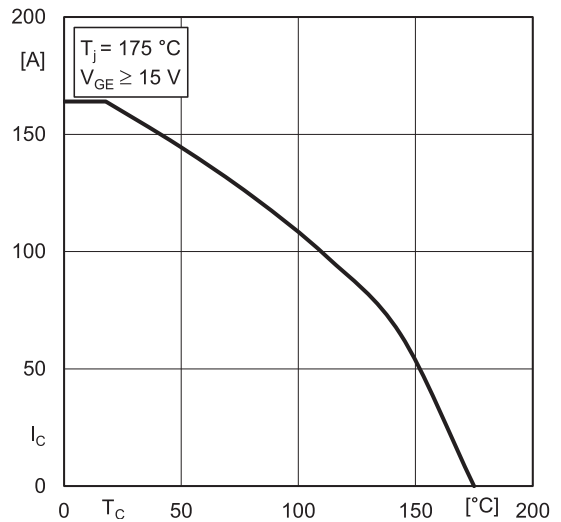


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

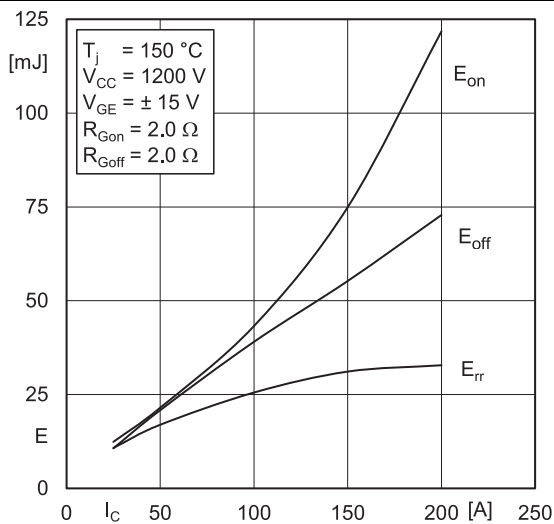


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

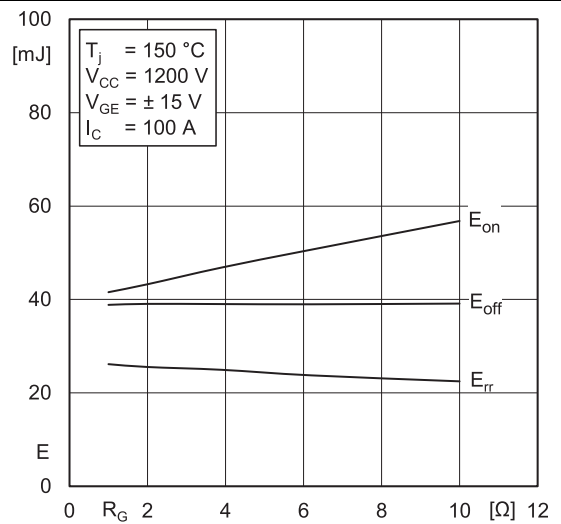


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

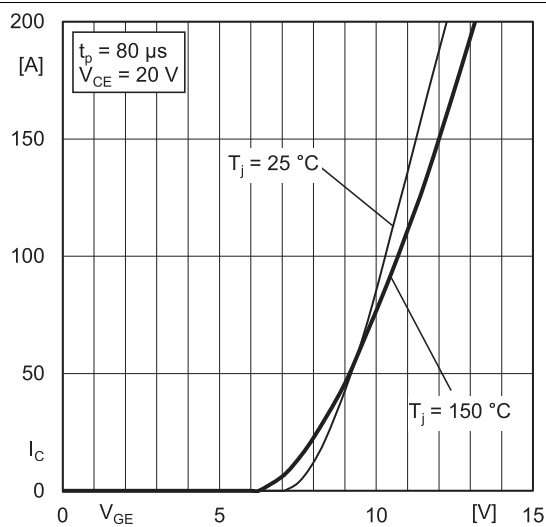


Fig. 5: Typ. transfer characteristic

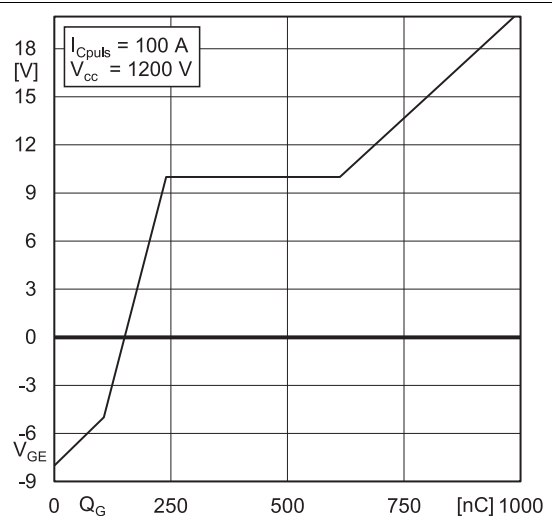


Fig. 6: Typ. gate charge characteristic

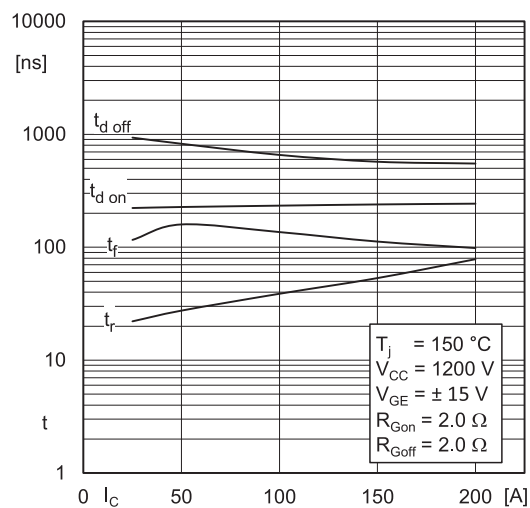


Fig. 7: Typ. switching times vs. I_C

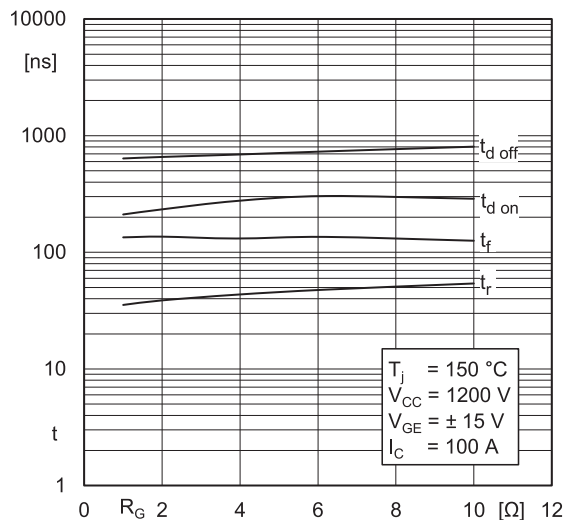


Fig. 8: Typ. switching times vs. gate resistor R_G

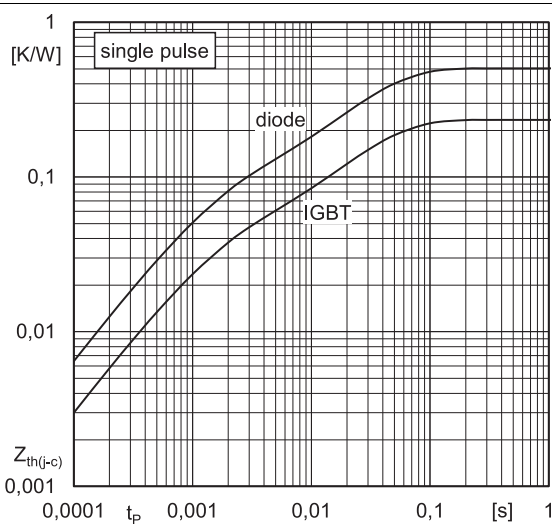


Fig. 9: Transient thermal impedance

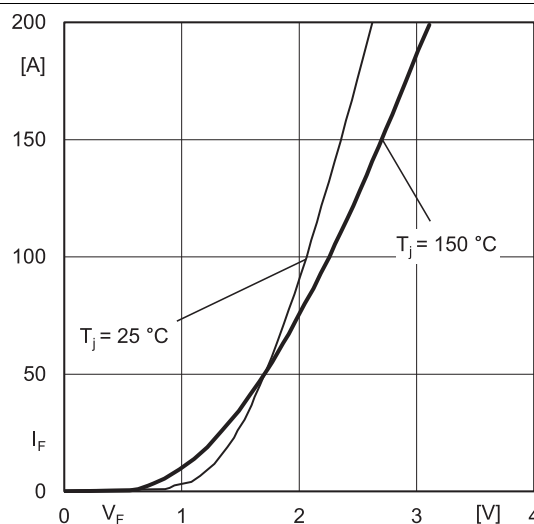


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC'} + EE'$

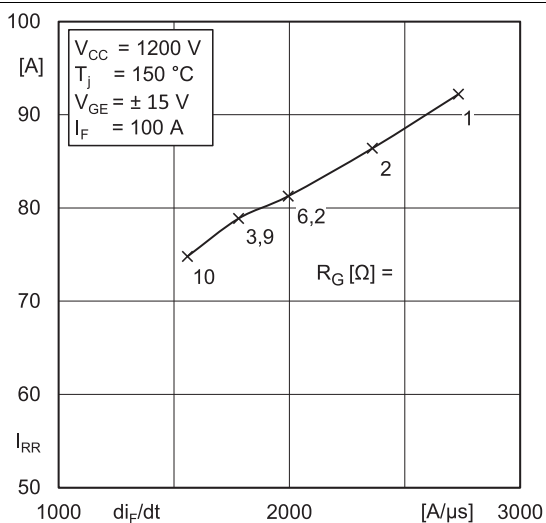


Fig. 11: CAL diode peak reverse recovery current

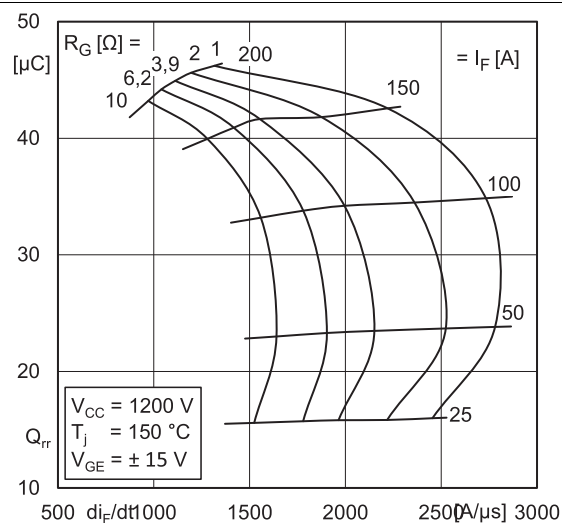
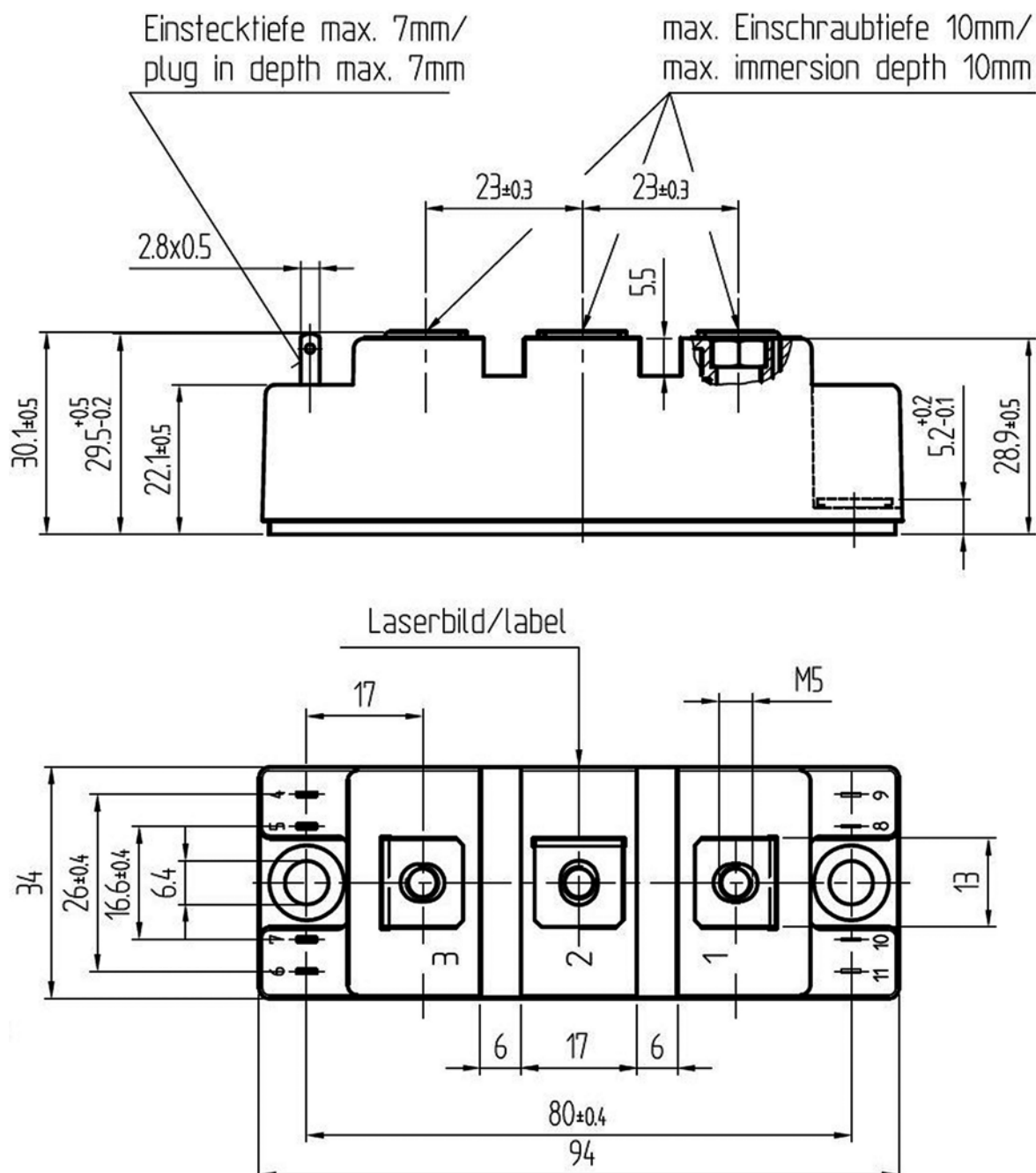
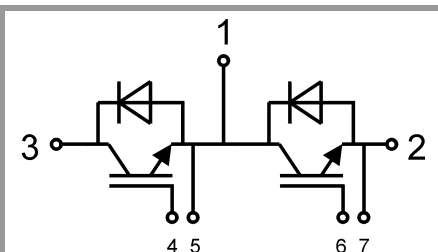


Fig. 12: Typ. CAL diode peak reverse recovery charge



SEMITRANS 2



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.